



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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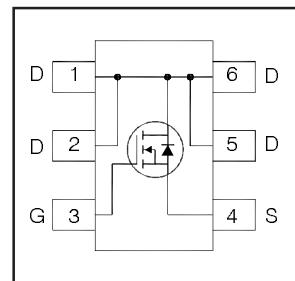
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

IRFT8342PbF

HEXFET® Power MOSFET

V_{DS}	30	V
V_{GS}	±20	V
R_{DS(on)} max (@V _{GS} = 10V)	19	mΩ
R_{DS(on)} max (@V _{GS} = 4.5V)	29	mΩ
Q_{g (typical)}	4.8	nC
I_D (@T _A = 25°C)	8.2	A



Applications

- System/Load Switch

Features and Benefits

Features

Industry-Standard TSOP-6 Package

RoHS Compliant Containing no Lead, no Bromide and no Halogen

MSL1, Consumer Qualification

Resulting Benefits

Multi-Vendor Compatibility

Environmentally Friendlier

Increased Reliability

Orderable part number	Package Type	Standard Pack		Note
		Form	Quantity	
IRFT8342TRPBF	TSOP-6	Tape and Reel	3000	

Absolute Maximum Ratings

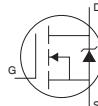
	Parameter	Max.	Units
V _{DS}	Drain-to-Source Voltage	30	V
V _{GS}	Gate-to-Source Voltage	±20	
I _D @ T _A = 25°C	Continuous Drain Current, V _{GS} @ 10V	8.2	A
I _D @ T _A = 70°C	Continuous Drain Current, V _{GS} @ 10V	6.6	
I _{DM}	Pulsed Drain Current ①	80	
P _D @ T _A = 25°C	Power Dissipation ③	2.0	W
P _D @ T _A = 70°C	Power Dissipation ③	1.3	
	Linear Derating Factor	0.02	W/°C
T _J	Operating Junction and	-55 to + 150	°C
T _{STG}	Storage Temperature Range		

Notes ① through ④ are on page 2

Static @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
BV_{DSS}	Drain-to-Source Breakdown Voltage	30	—	—	V	$V_{GS} = 0\text{V}$, $I_D = 250\mu\text{A}$
$\Delta BV_{DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient	—	18	—	mV/ $^\circ\text{C}$	Reference to 25°C , $I_D = 1\text{mA}$
$R_{DS(on)}$	Static Drain-to-Source On-Resistance	—	15	19	$\text{m}\Omega$	$V_{GS} = 10\text{V}$, $I_D = 8.2\text{A}$ ②
		—	22	29		$V_{GS} = 4.5\text{V}$, $I_D = 6.6\text{A}$ ②
$V_{GS(th)}$	Gate Threshold Voltage	1.35	1.80	2.35	V	$V_{DS} = V_{GS}$, $I_D = 25\mu\text{A}$
$\Delta V_{GS(th)}$	Gate Threshold Voltage Coefficient	—	-5.7	—	mV/ $^\circ\text{C}$	
I_{DSS}	Drain-to-Source Leakage Current	—	—	1.0	μA	$V_{DS} = 24\text{V}$, $V_{GS} = 0\text{V}$
		—	—	150		$V_{DS} = 24\text{V}$, $V_{GS} = 0\text{V}$, $T_J = 125^\circ\text{C}$
I_{GSS}	Gate-to-Source Forward Leakage	—	—	100	nA	$V_{GS} = 20\text{V}$
	Gate-to-Source Reverse Leakage	—	—	-100		$V_{GS} = -20\text{V}$
g_{fs}	Forward Transconductance	12	—	—	S	$V_{DS} = 10\text{V}$, $I_D = 6.6\text{A}$
Q_g	Total Gate Charge	—	4.8	—	nC	$V_{GS} = 4.5\text{V}$
Q_{gs}	Gate-to-Source Charge	—	2.1	—		$V_{DS} = 15\text{V}$
Q_{gd}	Gate-to-Drain Charge	—	1.6	—		$I_D = 6.6\text{A}$
R_G	Gate Resistance	—	2.6	—	Ω	
$t_{d(on)}$	Turn-On Delay Time	—	7.3	—	ns	$V_{DD} = 15\text{V}$, $V_{GS} = 4.5\text{V}$ ③
t_r	Rise Time	—	15	—		$I_D = 6.6\text{A}$
$t_{d(off)}$	Turn-Off Delay Time	—	9.1	—		$R_G = 6.8\Omega$
t_f	Fall Time	—	8.2	—		
C_{iss}	Input Capacitance	—	560	—	pF	$V_{GS} = 0\text{V}$
C_{oss}	Output Capacitance	—	102	—		$V_{DS} = 25\text{V}$
C_{rss}	Reverse Transfer Capacitance	—	48	—		$f = 1.0\text{MHz}$

Diode Characteristics

	Parameter	Min.	Typ.	Max.	Units	Conditions
I_s	Continuous Source Current (Body Diode)	—	—	2.5	A	MOSFET symbol showing the integral reverse p-n junction diode.
I_{SM}	Pulsed Source Current (Body Diode) ①	—	—	80		
V_{SD}	Diode Forward Voltage	—	—	1.0	V	$T_J = 25^\circ\text{C}$, $I_S = 6.6\text{A}$, $V_{GS} = 0\text{V}$ ②
t_{rr}	Reverse Recovery Time	—	8.2	12	ns	$T_J = 25^\circ\text{C}$, $I_F = 6.6\text{A}$, $V_{DD} = 24\text{V}$
Q_{rr}	Reverse Recovery Charge	—	4.5	5.4	nC	$dI/dt = 100/\mu\text{s}$ ②

Thermal Resistance

	Parameter	Typ.	Max.	Units
R_{0JA}	Junction-to-Ambient ③	—	62.5	$^\circ\text{C/W}$

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Pulse width $\leq 400\mu\text{s}$; duty cycle $\leq 2\%$.
- ③ When mounted on 1 inch square copper board.

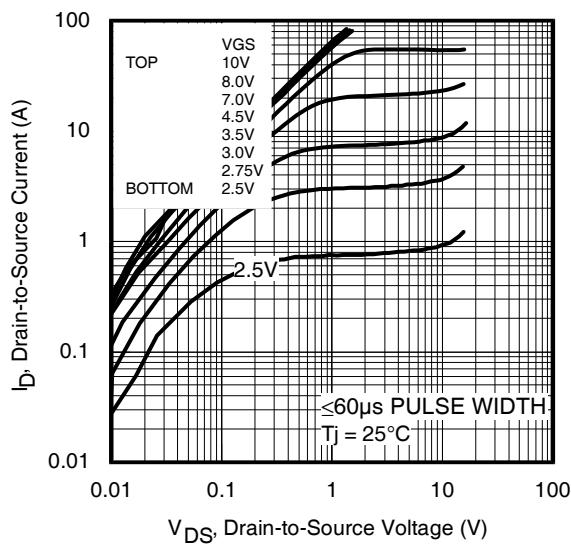


Fig 1. Typical Output Characteristics

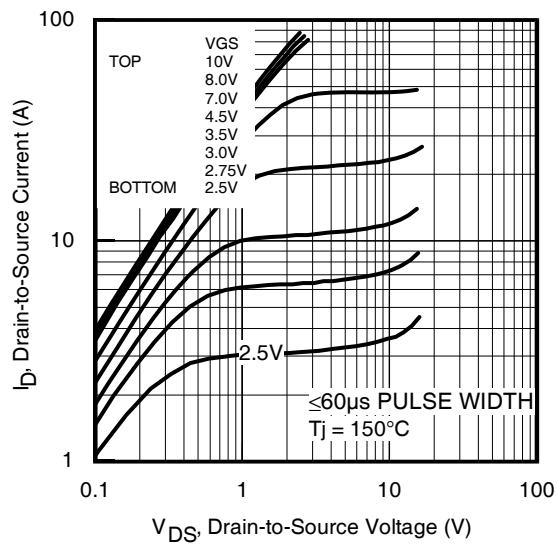


Fig 2. Typical Output Characteristics

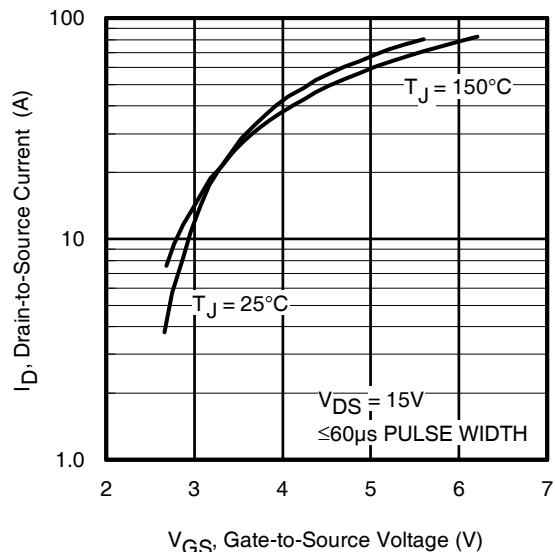


Fig 3. Typical Transfer Characteristics

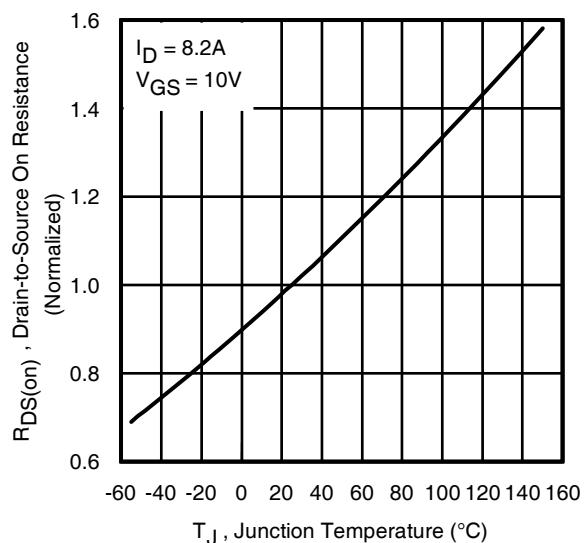


Fig 4. Normalized On-Resistance vs. Temperature

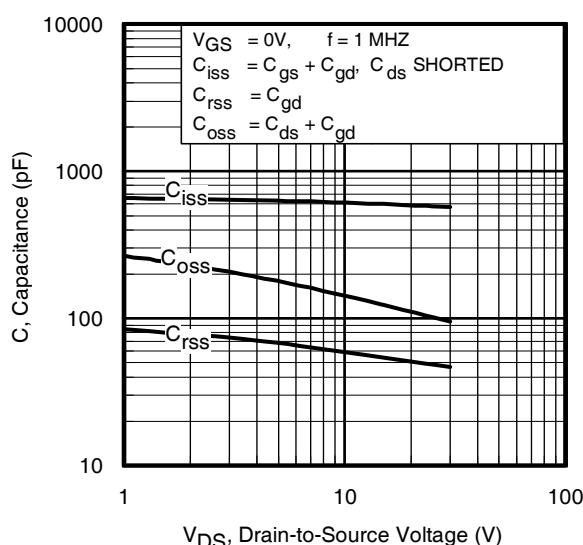


Fig 5. Typical Capacitance vs. Drain-to-Source Voltage
www.irf.com

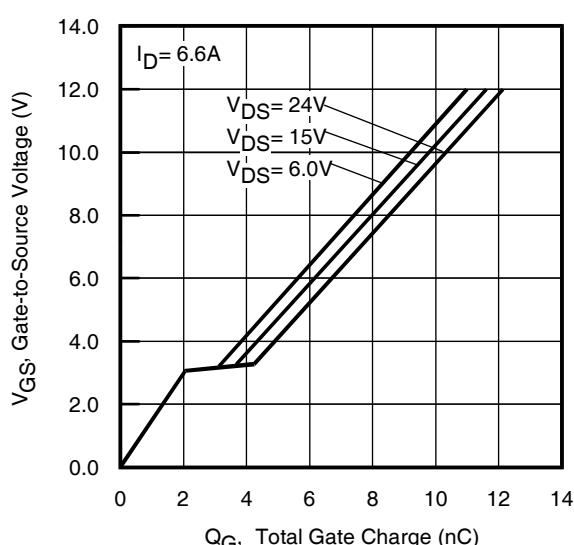


Fig 6. Typical Gate Charge vs. Gate-to-Source Voltage

IRFTS8342PbF

International
I²R Rectifier

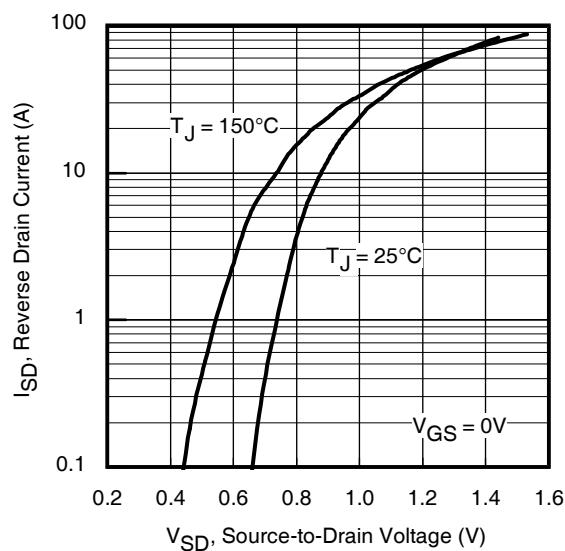


Fig 7. Typical Source-Drain Diode Forward Voltage

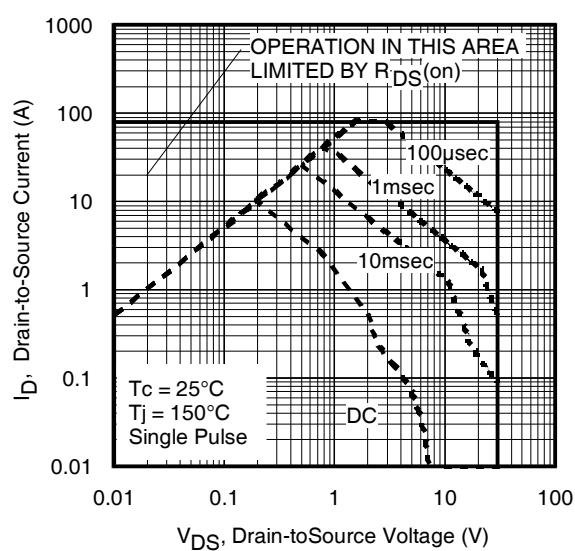


Fig 8. Maximum Safe Operating Area

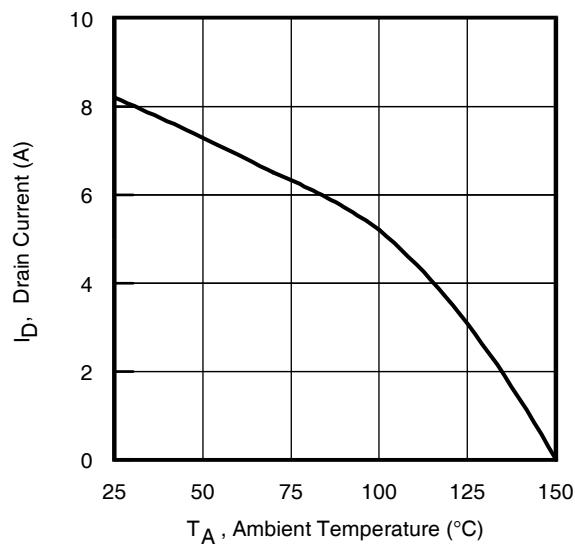


Fig 9. Maximum Drain Current vs.
Ambient Temperature

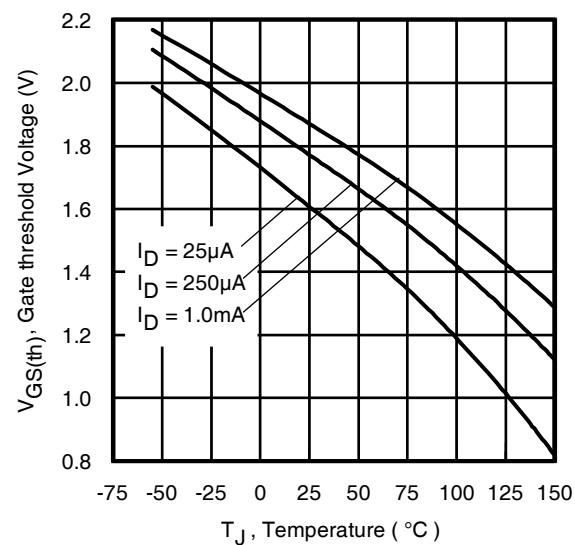


Fig 10. Threshold Voltage vs. Temperature

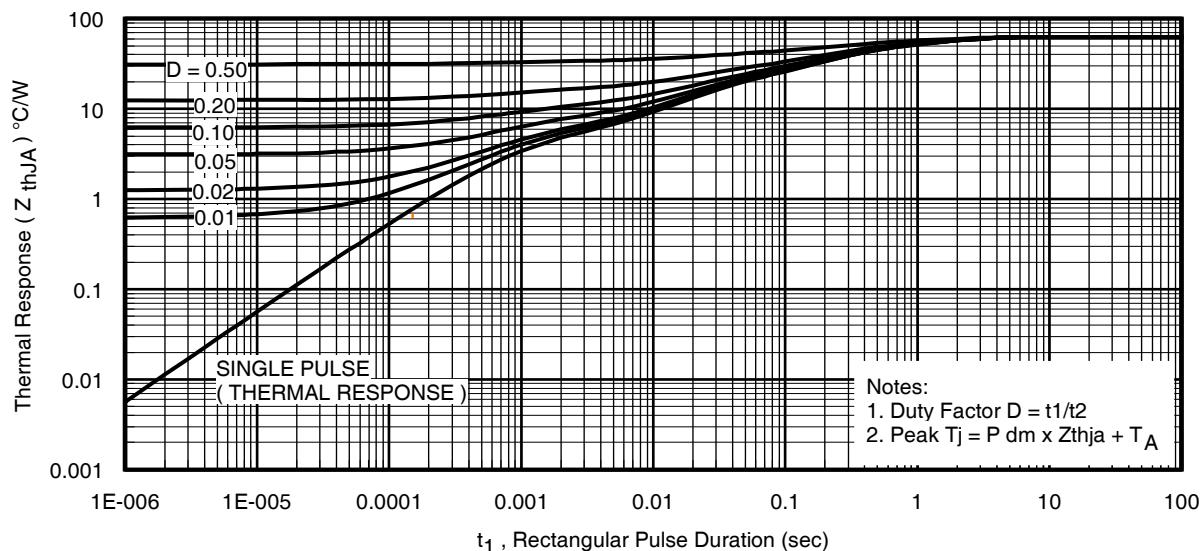


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

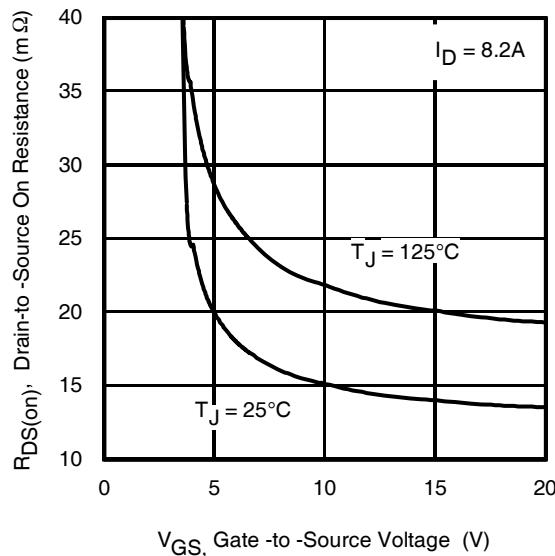


Fig 12. On-Resistance vs. Gate Voltage

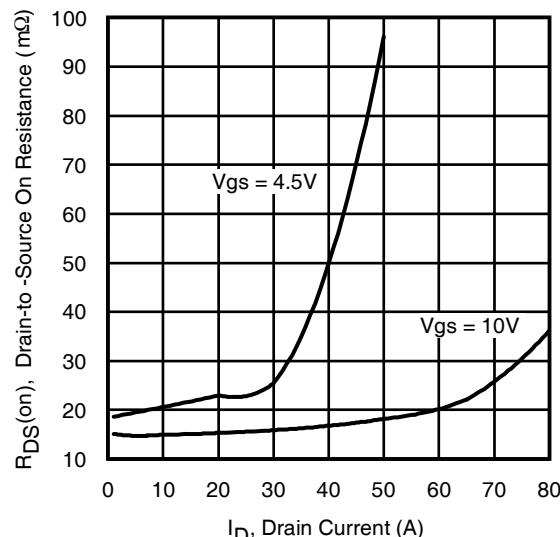


Fig 13. Typical On-Resistance vs. Drain Current

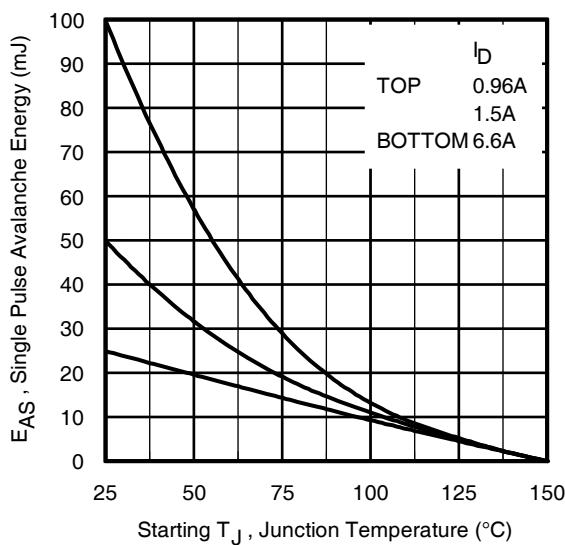


Fig 14. Maximum Avalanche Energy vs. Drain Current

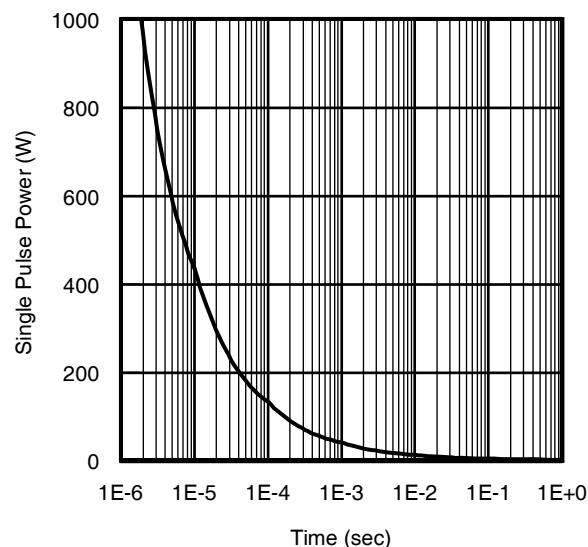


Fig 15. Typical Power vs. Time

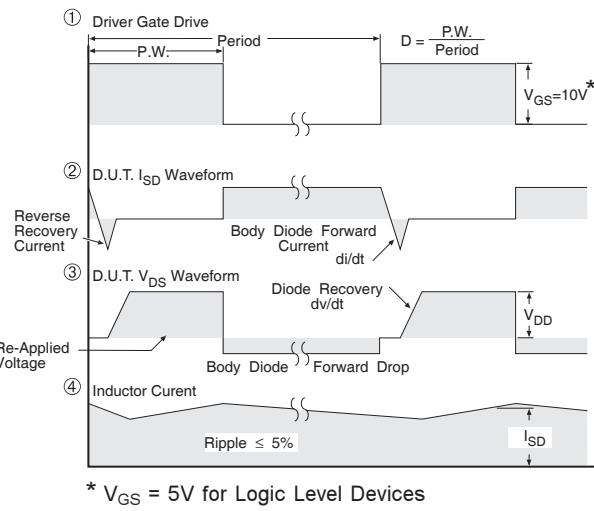
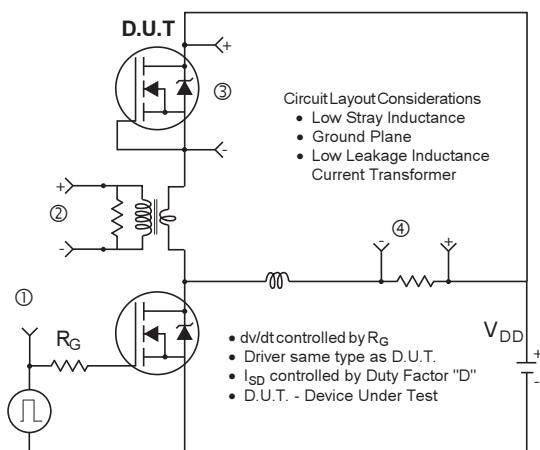


Fig 16. Peak Diode Recovery dv/dt Test Circuit for N-Channel HEXFET® Power MOSFETs

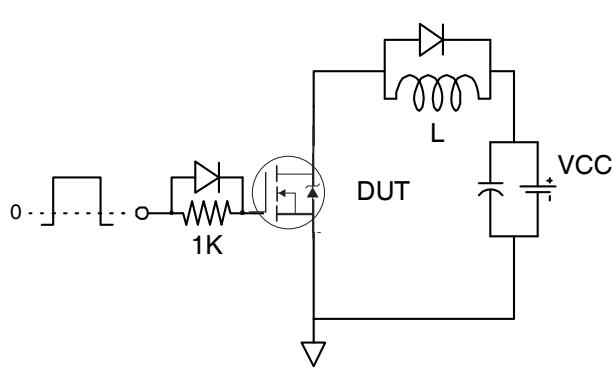


Fig 17a. Gate Charge Test Circuit

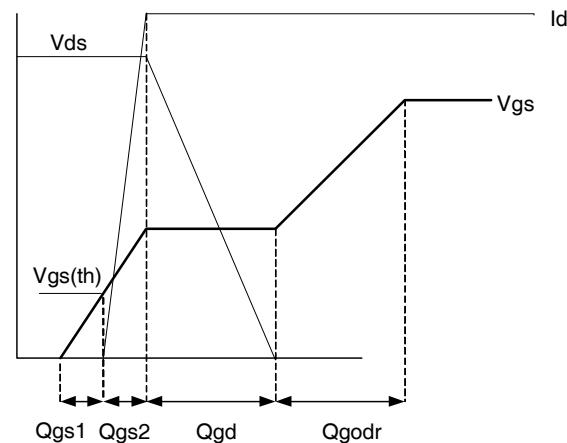


Fig 17b. Gate Charge Waveform

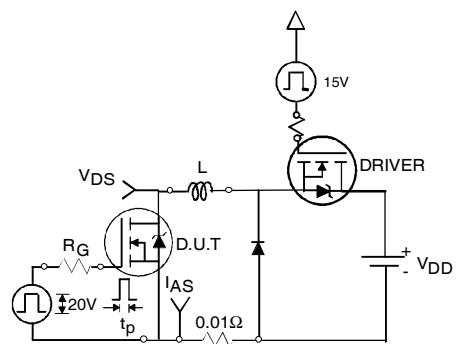


Fig 18a. Unclamped Inductive Test Circuit

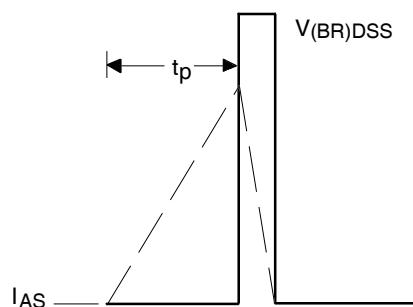


Fig 18b. Unclamped Inductive Waveforms

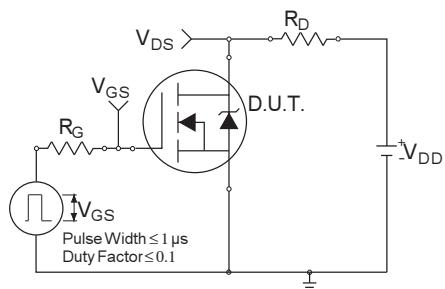


Fig 19a. Switching Time Test Circuit

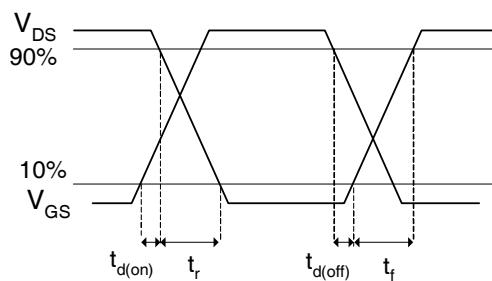
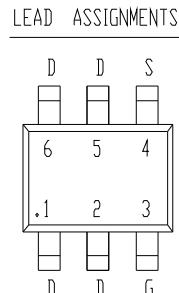
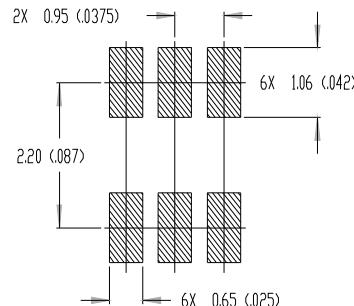
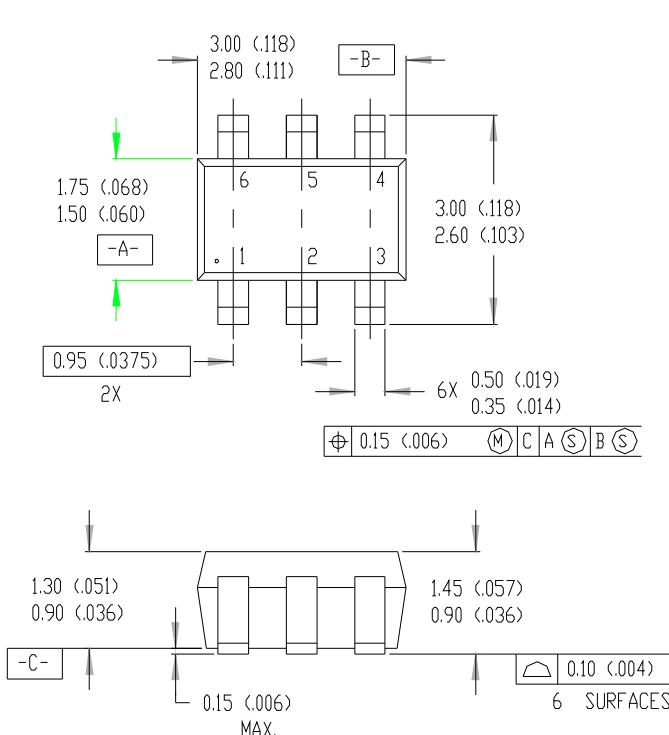


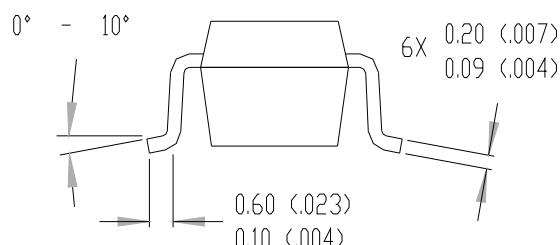
Fig 19b. Switching Time Waveforms

TSOP-6 Package Outline

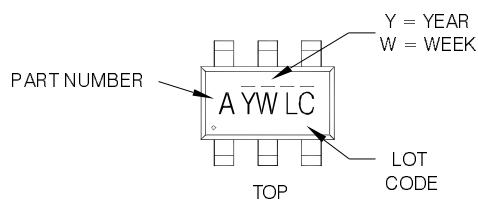


NOTES:

1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).



TSOP-6 Part Marking Information



PART NUMBER CODE REFERENCE:

A = SI3443DV	O = IRLTS6342TRPBF
B = IRF5800	P = IRFTS8342TRPBF
C = IRF5850	R = IRFTS9342TRPBF
D = IRF5851	S = Not applicable
E = IRF5852	T = IRLTS2242TRPBF
F = IRF5801	
G = IRF5803	
H = IRF5804	
I = IRF5805	
J = IRF5806	
K = IRF5810	
N = IRF5802	

Note: A line above the work week
(as shown here) indicates Lead-Free.

DATE CODE MARKING INSTRUCTIONS

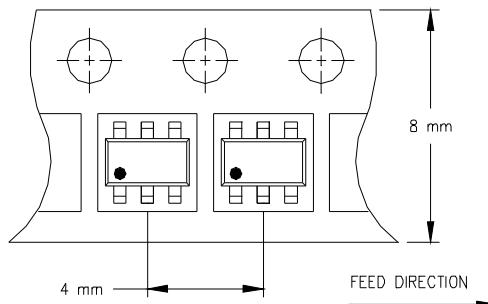
WW = (1-26) IF PRECEDED BY LAST DIGIT OF CALENDAR YEAR

YEAR	Y	WORK WEEK	W
2011	2001	01	A
2012	2002	02	B
2013	2003	03	C
2014	2004	04	D
2015	2005	5	
2016	2006	6	
2017	2007	7	
2018	2008	8	
2019	2009	9	
2020	2010	0	X
		24	
		25	Y
		26	Z

WW = (27-52) IF PRECEDED BY A LETTER

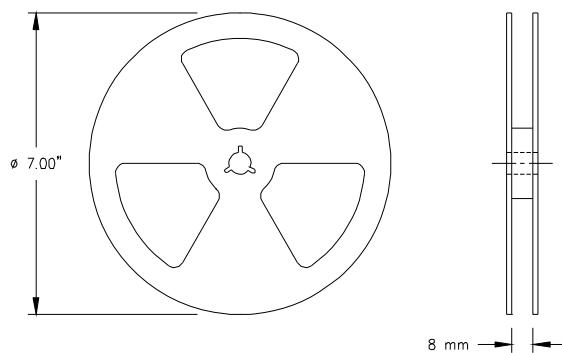
YEAR	Y	WORK WEEK	W
2011	2001	A	27
2012	2002	B	28
2013	2003	C	29
2014	2004	D	30
2015	2005	E	
2016	2006	F	
2017	2007	G	
2018	2008	H	
2019	2009	J	
2020	2010	K	
		50	X
		51	Y
		52	Z

TSOP-6 Tape & Reel Information



NOTES:

- OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES:

- OUTLINE CONFORMS TO EIA-481 & EIA-541.

Qualification information[†]

Qualification level	Consumer ^{††} (per JEDEC JESD47F ^{†††} guidelines)	
Moisture Sensitivity Level	TSOP-6	MSL1 (per JEDEC J-STD-020D ^{†††})
RoHS compliant	Yes	

[†] Qualification standards can be found at International Rectifier's web site
<http://www.irf.com/product-info/reliability>

^{††} Higher qualification ratings may be available should the user have such requirements.
 Please contact your International Rectifier sales representative for further information:
<http://www.irf.com/whoto-call/salesrep/>

^{†††} Applicable version of JEDEC standard at the time of product release.

Data and specifications subject to change without notice.

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